TOSHIBA Photocoupler Photorelay

TLP4597G

PBX

Telecommunication

Modem · FAX Cards, Modems In PC

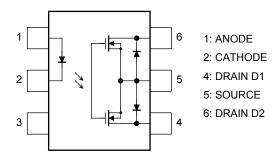
Measurement Instrumentation

The TOSHIBA TLP4597G consists of an aluminum gallium arsenide infrared emitting diode optically coupled to a photo-MOSFET in a six lead plastic DIP package (DIP6).

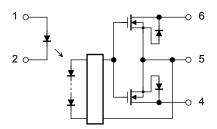
The TLP4597G is a bi-directional switch can replace mechanical relays in many applications.

- 6 pin DIP (DIP6)
- 1-form-B
- Peak off-state voltage: 350 V (min)
- Trigger LED current: 3 mA (max)
- On-state current: 150 mA (max)
- On-state resistance: 25Ω (max)
- Isolation voltage: 2500 Vrms (min)
- UL recognized: UL1577, File No. E67349

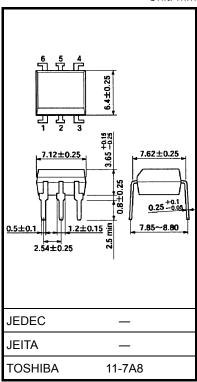
Pin Configuration (top view)



Schematic



Unit: mm



Weight: 0.4 g (typ.)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
	Forward current		l _F	50	mA
	Forward current derating (Ta ≧ 25°C)		ΔI _F /°C	-0.5	mA/°C
LED	Peak forward current (100 μs pulse, 100 pps)		I _{FP}	1	Α
	Reverse voltage		V_{R}	5	V
	Junction temperat	ure	Tj	125	°C
	Off-state output te	rminal voltage	V _{OFF}	350	V
	On-state current	A connection		150	
		B connection	Ion	150	mA
ctor		C connection		300	
Detector	On-state current	A connection		-1.5	
	derating (Ta ≧ 25°C)	B connection	Δl _{ON} /°C	-1.5	mA/°C
		C connection		-3.0	
	Junction temperat	ure	Tj	125	°C
Ope	rating temperature	range	T _{opr}	-40 to 85	°C
Stora	age temperature ra	nge	T _{stg}	-55 to 125	°C
Lead	d soldering tempera	ture (10 s)	T _{sol}	260	°C
	ation voltage 1 min, R.H. ≦ 60%) (Note 1)	BVS	2500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

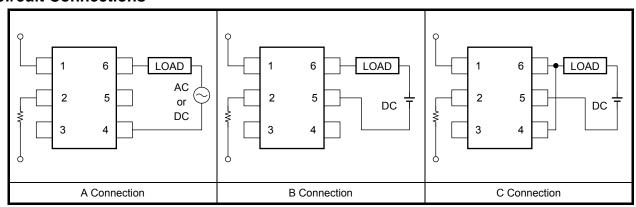
Note 1: Device considered a two-terminal device: LED side pins shorted together, and DETECTOR side pins shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	V_{DD}	_	_	280	V
Forward current	lF	5	_	25	mA
On-state current	I _{ON}	_	_	150	mA
Operating temperature	T _{opr}	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Circuit Connections



2

Individual Electrical Characteristics (Ta = 25°C)

	Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
CED	Forward voltage	V _F	I _F = 10 mA	1.0	1.15	1.3	V
	Reverse current	I _R	V _R = 5 V	_	_	10	μΑ
	Capacitance	C _T	V = 0, f = 1 MHz	_	30	_	pF
Detec- tor	Off-state current	loff	$V_{OFF} = 350 \text{ V}, I_F = 5 \text{ mA}$	_	_	1	μΑ
Det to	Capacitance	C _{OFF}	$V = 0, f = 1 \text{ MHz}, I_F = 5 \text{ mA}$		65	_	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current		I _{FC}	I _{OFF} = 10 μA	_	1	3	mA
Return LED current		I _{FT}	I _{ON} = 150 mA	0.1	_	_	mA
	A connection	•	I _{ON} = 150 mA	_	15	25	
On-state resistance	B connection		I _{ON} = 150 mA	_	8	14	Ω
	C connection		I _{ON} = 300 mA		4		

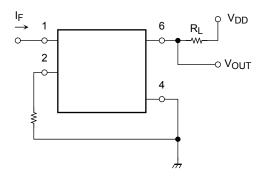
Isolation Characteristics (Ta = 25°C)

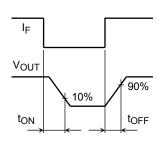
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	V _S = 0, f = 1 MHz	_	8.0	_	pF
Isolation resistance	R _S	V _S = 500 V, R.H. ≦ 60%	5×10^{10}	10 ¹⁴	_	Ω
	BVS	AC, 1 min	2500	_	_	Vrms
Isolation voltage		AC, 1 s, in oil	_	5000	_	
		DC, 1 min, in oil	_	5000	_	Vdc

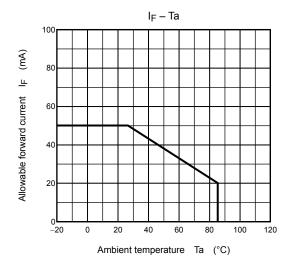
Switching Characteristics (Ta = 25°C)

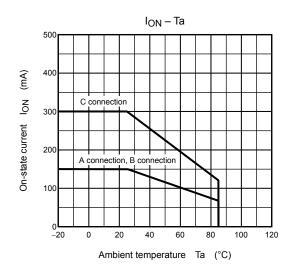
Characteristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Turn-on time	t _{ON}	$R_L = 200 \Omega$	(Note 2)	_	_	1	ms
Turn-off time	toff	$V_{DD} = 20 \text{ V}, I_F = 5 \text{ mA}$		_	_	3	ms

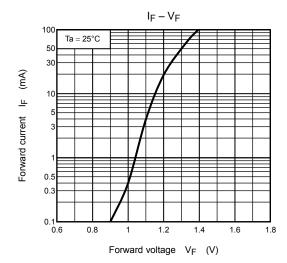
Note 2: Switching time test circuit

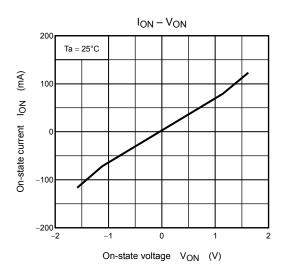


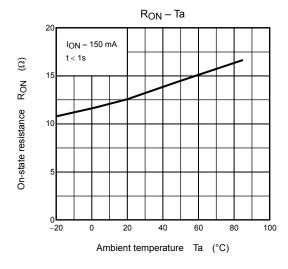


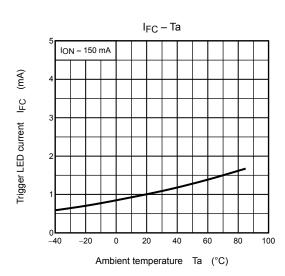


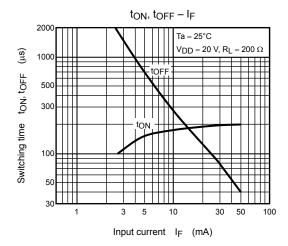


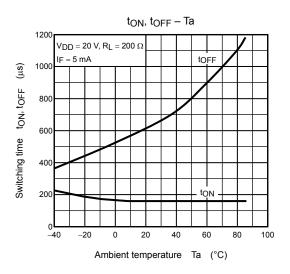


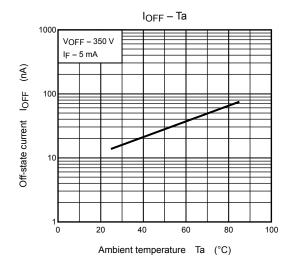












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